

ESD Protection Diodes Silicon Epitaxial Planar

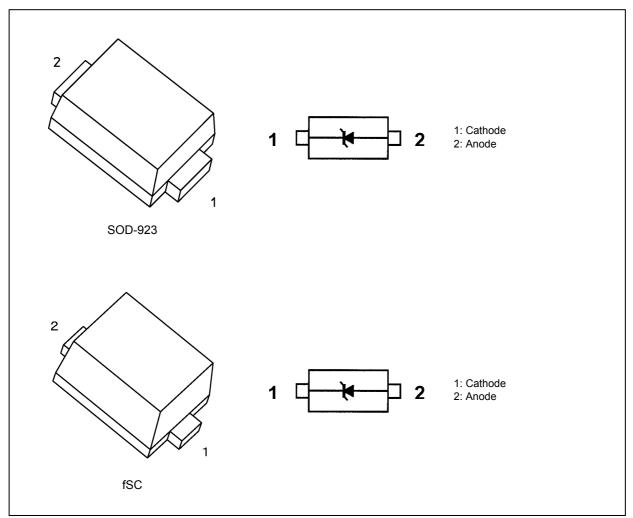
# **DF2S6.8FS**

#### 1. Applications

· ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

#### 2. Packaging and Internal Circuit



The SOD-923 package is recommended.

Package	Product name
SOD-923	DF2S6.8FS,L3M (Note 1)
fSC	DF2S6.8FS,L3J , DF2S6.8FS,L3F

Note 1: The product name of the devices housed in the SOD-923 package are suffixed with the "M".

Start of commercial production



#### 3. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)	V <sub>ESD</sub>	±30	kV
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 4. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25°C)

V<sub>RWM</sub>: Working peak reverse

voltage

Vz: Zener voltage

V<sub>BR</sub>: Reverse breakdown voltage

Z<sub>Z</sub>: Dynamic impedance

Iz: Zener current

I<sub>BR</sub>: Reverse breakdown current

I<sub>R</sub>: Reverse current V<sub>C</sub>: Clamp voltage

I<sub>PP</sub>: Peak pulse current

R<sub>DYN</sub>: Dynamic resistance I<sub>F</sub>: Forward current

V<sub>F</sub>: Forward voltage

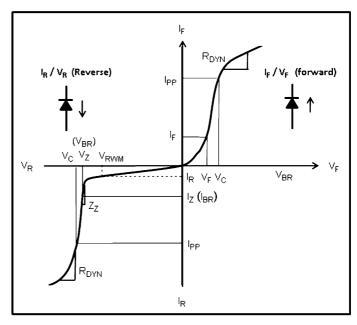


Fig. 4.1 Definitions of Electrical Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Working peak reverse voltage	$V_{RWM}$		_	_	_	5	V
Zener voltage (Reverse breakdown voltage)	V <sub>Z</sub> (V <sub>BR</sub> )		$I_Z = 5 \text{ mA}$ $(I_{BR})$	6.4	6.8	7.2	\ \
Dynamic impedance	Z <sub>Z</sub>		$I_Z = 5 \text{ mA}$ $(I_{BR})$			30	Ω
Reverse current	I <sub>R</sub>		V <sub>RWM</sub> = 5 V	_	_	0.5	μА
Clamp voltage	V <sub>C</sub>	(Note 1)	I <sub>PP</sub> = 1 A	_	9	_	V
Dynamic resistance	R <sub>DYN</sub>	(Note 2)	_	_	0.7	_	Ω
Total capacitance	Ct		V <sub>R</sub> = 0 V, f = 1 MHz	_	25		pF

Note 1: Based on IEC61000-4-5 8/20  $\mu s$  pulse.

Note 2: TLP parameter:  $Z0 = 50 \Omega$ , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns, extraction of dynamic resistance using a least-squares fit of TLP characteristics at  $I_{PP}$  between 3 A to 8 A.

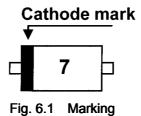


#### 5. Guaranteed ESD Protection (Note)

Test Condition	ESD Protection	
IEC61000-4-2 (Contact discharge)	±30 kV	

Note: Criterion: No damage to devices.

## 6. Marking



7. Land Pattern Dimensions (for reference only)

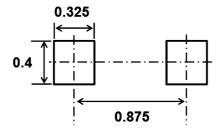


Fig. 7.1 SOD-923 (unit: mm)

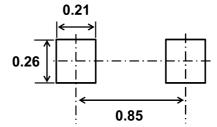
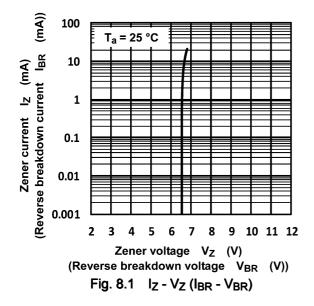


Fig. 7.2 fSC (unit: mm)

#### 8. Characteristics Curves (Note)



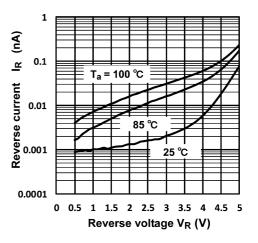
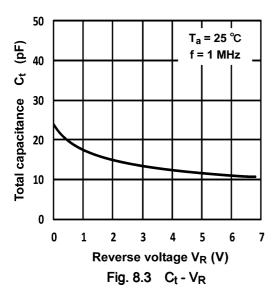
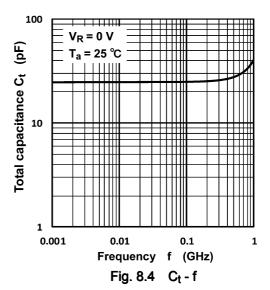


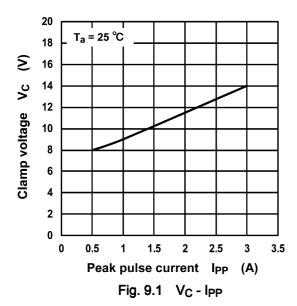
Fig. 8.2 I<sub>R</sub> - V<sub>R</sub>





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

#### 9. Clamp Voltage V<sub>C</sub> - Peak Pulse Current (I<sub>PP</sub>) (Note)



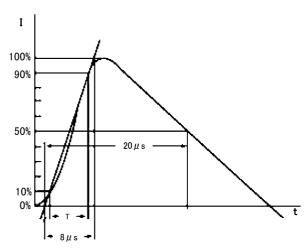
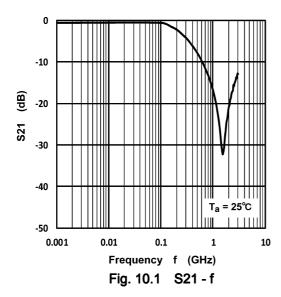
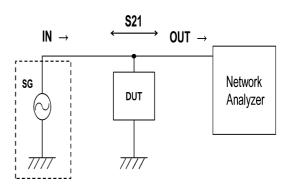


Fig. 9.2 Based on IEC61000-4-5 8/20  $\mu$ s pulse.

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

#### 10. Insertion Loss (S21) (Note)





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



#### 11. ESD Clamp Waveform (Note)

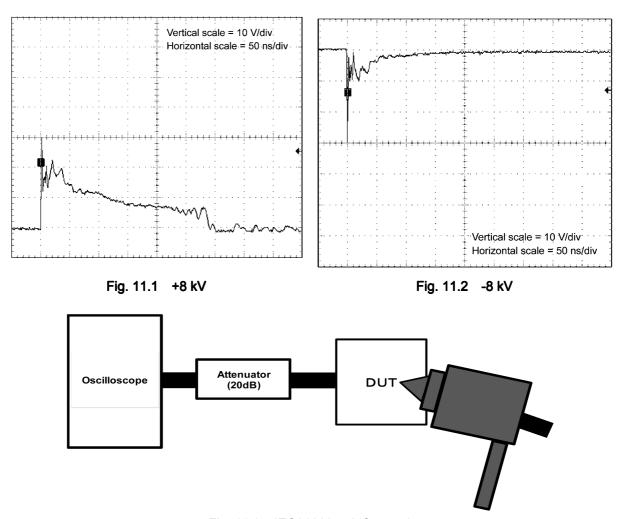


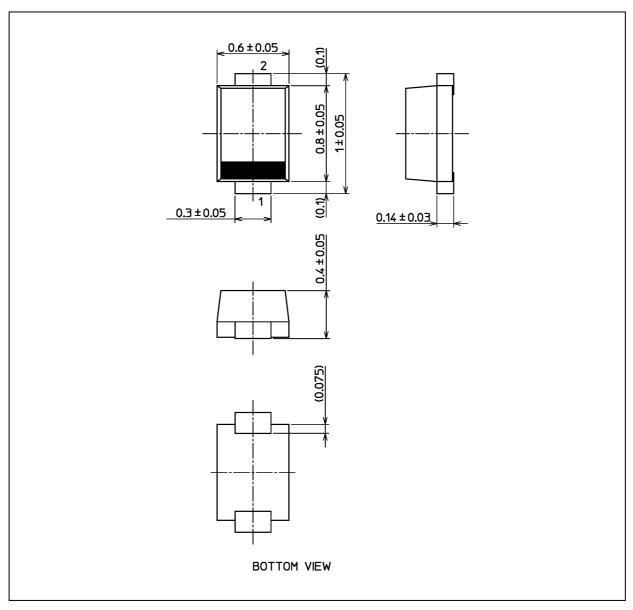
Fig. 11.3 IEC61000-4-2(Contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



#### **Package Dimensions**

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

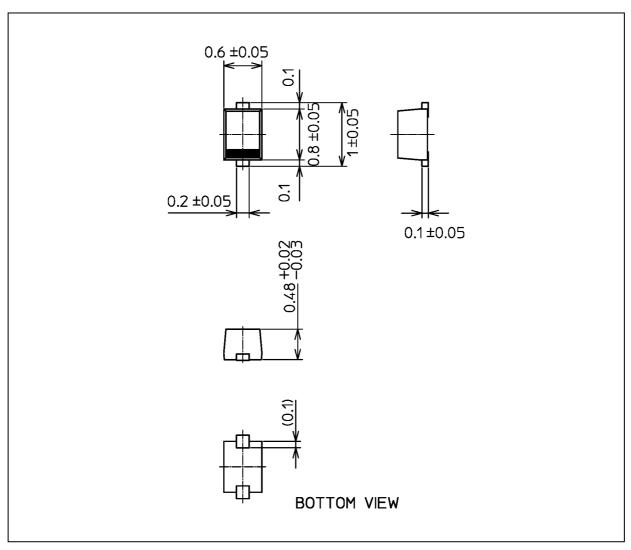
Weight: 0.55 mg (typ.)

I	Package Name(s)
TOSHIBA: 1-1AH1A	
Nickname: SOD-923	



#### **Package Dimensions**

Unit: mm



The shapes and dimensions of the package vary, depending on the manufacturing plant. For details, contact the Toshiba sales representative.

Weight: 0.6 mg (typ.)

F	Package Name(s)
TOSHIBA: 1-1L1S	
Nickname: fSC	



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